# International **ICR** Rectifier

### POWER MOSFET THRU-HOLE (TO-254AA)

#### **Product Summary**

Part Number	RDS(on)	ID	
IRFM350	0.315 Ω	14A	

HEXFET® MOSFET technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry design achieves very low on-state resistance combined with high transconductance. HEXFET transistors also feature all of the well-established advantages of MOSFETs, such as voltage control, very fast switching, ease of paralleling and electrical parameter temperature stability. They are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and virtually any application where high reliability is required. The HEXFET transistor's totally isolated package eliminates the need for additional isolating material between the device and the heatsink. This improves thermal efficiency and reduces drain capacitance.

# PD - 90491D

### IRFM350 JANTX2N7227 JANTXV2N7227 REF:MIL-PRF-19500/592 400V, N-CHANNEL HEXFET<sup>®</sup> MOSFETTECHNOLOGY



#### Features:

- Simple Drive Requirements
- Ease of Paralleling
- Hermetically Sealed
- Electrically Isolated
- Dynamic dv/dt Rating
- Light-weight

	Parameter		Units	
ID @ VGS = 10V, TC = 25°C Continuous Drain Current		14		
ID @ VGS = 10V, TC = 100°C Continuous Drain Current		9.0	A	
IDM	Pulsed Drain Current ①	56	1	
P <sub>D</sub> @ T <sub>C</sub> = 25°C	Max. Power Dissipation	150	W	
	Linear Derating Factor	1.2	W/°C	
VGS	Gate-to-Source Voltage	±20	V	
EAS	Single Pulse Avalanche Energy 2	700	mJ	
IAR	Avalanche Current ①	14	А	
EAR	Repetitive Avalanche Energy ①	15	mJ	
dv/dt	Peak Diode Recovery dv/dt 3	4.0	V/ns	
ТJ	Operating Junction	-55 to 150		
TSTG	Storage Temperature Range		°C	
	Lead Temperature	300 ( 0.063 in.(1.6mm) from case for 10s)		
	Weight	9.3 (Typical)	g	

### **Absolute Maximum Ratings**

For footnotes refer to the last page

# International

### **Electrical Characteristics** @ Tj = 25°C (Unless Otherwise Specified)

	Parameter	Min	Тур	Max	Units	Test Conditions
BVDSS	Drain-to-Source Breakdown Voltage	400	_	—	V	$V_{GS} = 0V, I_{D} = 1.0mA$
$\Delta BV_{DSS}/\Delta T_{J}$	Temperature Coefficient of Breakdown Voltage	_	0.46	_	V/°C	Reference to 25°C, $I_D = 1.0$ mA
RDS(on)	Static Drain-to-Source On-State	—	_	0.315	Ω	VGS = 10V, ID = 9.0A (4)
	Resistance	—	—	0.415	32	VGS = 10V, ID = 14A
VGS(th)	Gate Threshold Voltage	2.0	—	4.0	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$
9fs	Forward Transconductance	6.0	—	—	S (ひ)	V <sub>DS</sub> > 15V, I <sub>DS</sub> = 9.0A ④
IDSS	Zero Gate Voltage Drain Current	—	—	25	μA	V <sub>DS</sub> = 320V ,V <sub>GS</sub> =0V
		—	—	250	μΑ	V <sub>DS</sub> = 320V,
						VGS = 0V, TJ = 125°C
IGSS	Gate-to-Source Leakage Forward	_	—	100		$V_{GS} = 20V$
IGSS	Gate-to-Source Leakage Reverse	—	_	-100	nA	V <sub>GS</sub> = -20V
Qg	Total Gate Charge	—	—	110		VGS =10V, ID = 14A
Qgs	Gate-to-Source Charge	_	_	18	nC	V <sub>DS</sub> =200V
Qgd	Gate-to-Drain ('Miller') Charge	—	—	65		
<sup>t</sup> d(on)	Turn-On Delay Time	_	_	35		V <sub>DD</sub> = 200V, I <sub>D</sub> = 14A,
tr	Rise Time	—	—	190		$V_{GS}$ =10V, $R_{G}$ = 2.35 $\Omega$
<sup>t</sup> d(off)	Turn-Off Delay Time	_	_	170	ns	
tf	Fall Time	—	—	130		
L <sub>S</sub> +L <sub>D</sub>	Total Inductance		4.0		nH	Measured from drain lead (6mm/ 0.25in. from package) to source lead (6mm/0.25in. from package)
C <sub>iss</sub>	Input Capacitance		2600	_		VGS = 0V, VDS = 25V
C <sub>OSS</sub>	Output Capacitance	_	660		pF	f = 1.0MHz
C <sub>rss</sub>	Reverse Transfer Capacitance	—	250	—		

### **Source-Drain Diode Ratings and Characteristics**

	Parameter	Min	Тур	Max	Units	Test Conditions
IS	Continuous Source Current (Body Diode)	_	_	14	Δ	
ISM	Pulse Source Current (Body Diode) ①	_	_	56	Α	
VSD	Diode Forward Voltage	_	_	1.7	V	$T_j = 25^{\circ}C, I_S = 14A, V_{GS} = 0V ④$
trr	Reverse Recovery Time	—	—	1200	nS	Tj = 25°C, IF = 14A, di/dt ≤ 100A/μs
QRR	Reverse Recovery Charge	-	—	11	μC	$V_{DD} \leq 50V $ (4)
ton	Forward Turn-On Time Intrinsic turn-o	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by $L_{S}$ + $L_{D}$ .				

### **Thermal Resistance**

	Parameter	Min	Тур	Мах	Units	Test Conditions
RthJC	Junction-to-Case	—	—	0.83		
RthCS	Case-to-sink	—	0.21	—	°C/W	
R <sub>th</sub> JA	Junction-to-Ambient	—	-	48		Typical socket mount

#### Note: Corresponding Spice and Saber models are available on the G&S Website.

For footnotes refer to the last page

# International

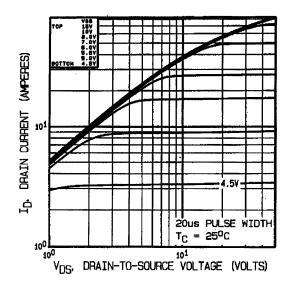


Fig 1. Typical Output Characteristics

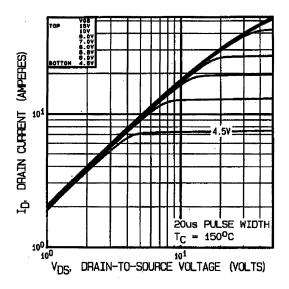


Fig 2. Typical Output Characteristics

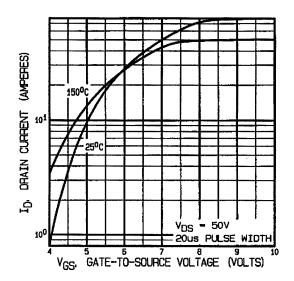


Fig 3. Typical Transfer Characteristics

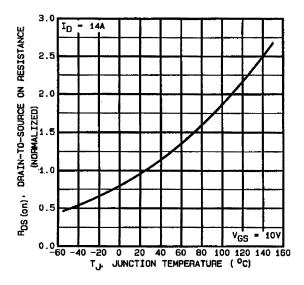
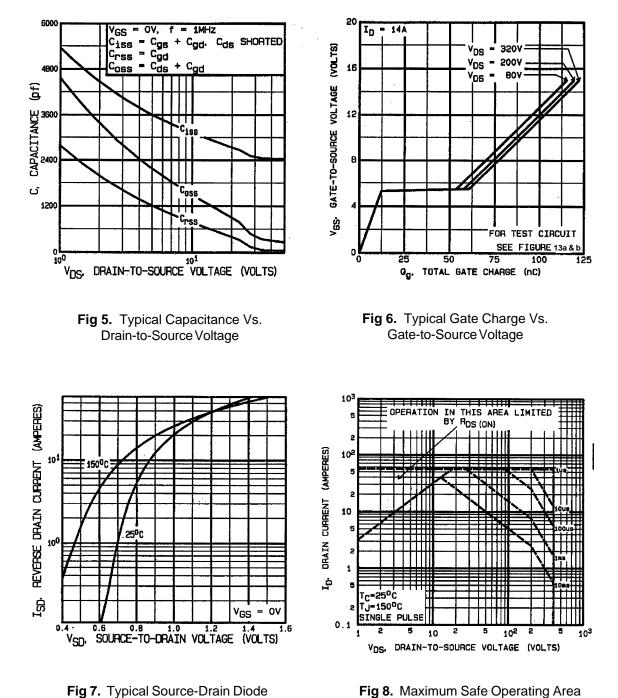


Fig 4. Normalized On-Resistance Vs. Temperature

www.irf.com

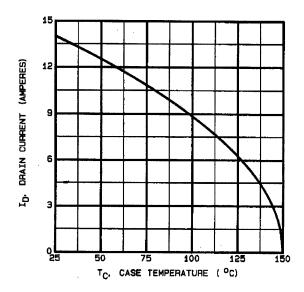
International **ICR** Rectifier

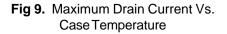


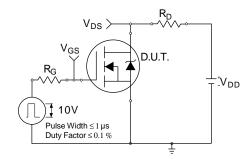
www.irf.com

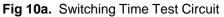
Forward Voltage

# International









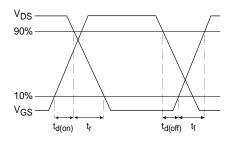


Fig 10b. Switching Time Waveforms

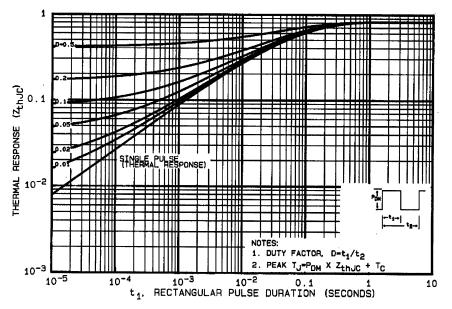


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

## International

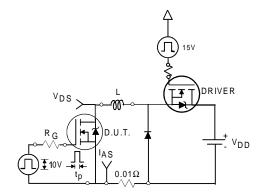


Fig 12a. Unclamped Inductive Test Circuit

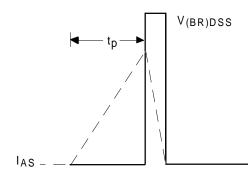


Fig 12b. Unclamped Inductive Waveforms

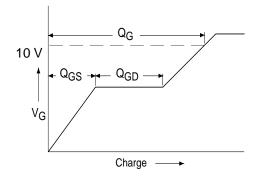


Fig 13a. Basic Gate Charge Waveform

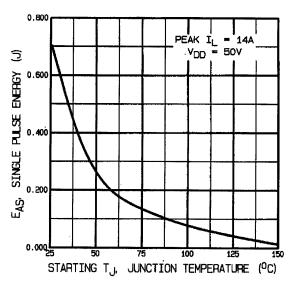


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

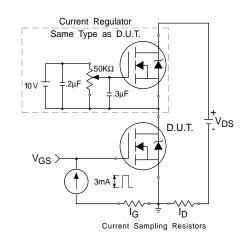


Fig 13b. Gate Charge Test Circuit

## International

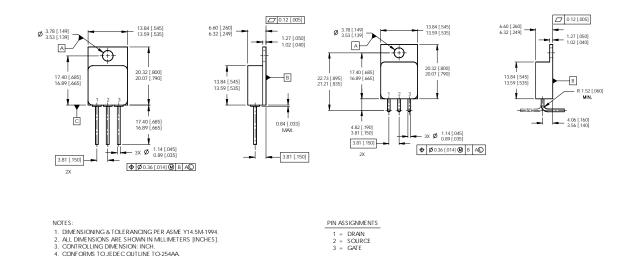
#### Footnotes:

 Repetitive Rating; Pulse width limited by maximum junction temperature.

 $@~V_{DD}$  = 50V, starting TJ = 25°C, L= 7.1mH Peak IL = 14A, VGS = 10V

Case Outline and Dimensions — SMD-1

- ④ Pulse width  $\leq$  300 µs; Duty Cycle  $\leq$  2%



#### CAUTION BERYLLIA WARNING PER MIL-PRF-19500

Packages containing beryllia shall not be ground, sandblasted, machined or have other operations performed on them which will produce beryllia or beryllium dust. Furthermore, beryllium oxide packages shall not be placed in acids that will produce fumes containing beryllium.

# International

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105 TAC Fax: (310) 252-7903 Visit us at www.irf.com for sales contact information. Data and specifications subject to change without notice. 01/02